

Pixellated Planar Bolometer Imaging Arrays

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Summary

- Pixellated imaging arrays – Motivation
- Practical realizations and parameters
- Design considerations and limitations
- How to make thing black – Materials, topologies and modeling absorbers
- Tracking the imaging properties – inter-element correlations and resolution

Continuum Science Drivers: Extended Source Mapping

- Star Formation Regions
 - Accretion / Debris Disks
 - Cold Protostellar Gas
 - Dust Emission
- Planetary, Kuiper Belt, and Comets
- Universe at High Red Shift
 - Continuum Surveys / Polarimetry
 - Cosmology
 - Galaxy Clustering
 - SZ / Cosmic Microwave Background
 - Photometric Survey Support

Single-Mode Detector:
Matched to Point Source

$$P = S A$$

Single-Mode Detector:
Distributed Source

$$P = k_b T$$

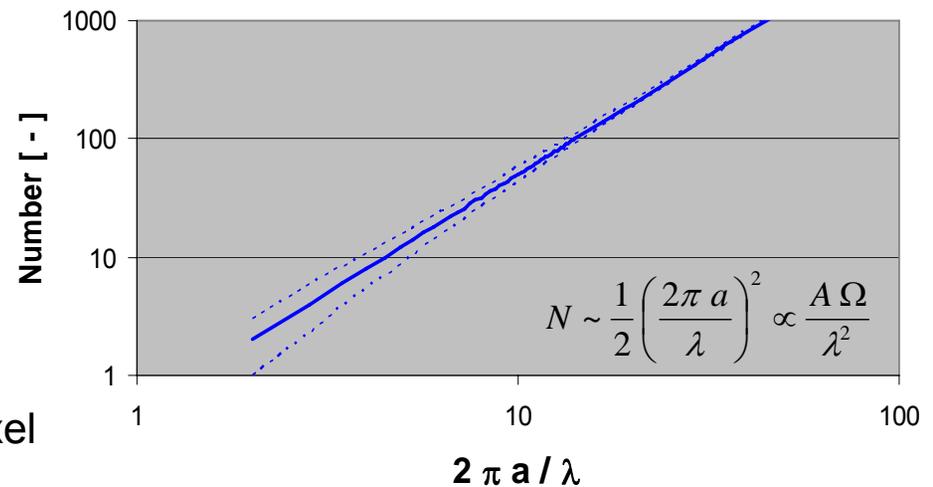
Multimode Array:
Distributed Source
detectors, m-modes/pixel

$$P_n \approx m k_b T$$

Large Area Detector:
Distributed Source

$$P = \frac{2k_b T}{\lambda^2} \int A \cdot d\Omega$$

Total Propagating Modes:



In principle, a well implemented multimode array is able to more rapidly map an *extended image* while maintaining low noise, high intrinsic detector speed, angular resolution, and control over atmospheric noise...



Telescope Primary:

- Low Pass Spatial Filter

Re-imaging Optics:

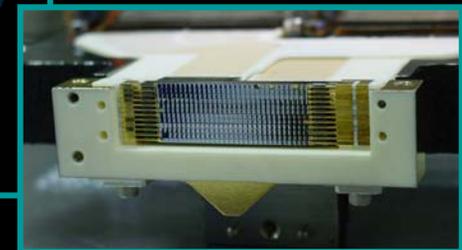
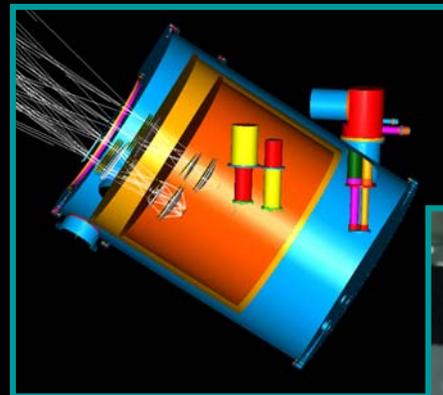
- Beam Waveguide to Detector
- Filtering to Define Spectral Response
- Cold Baffling to Limit Sensor FOV

Cryostat and Supporting Electronics:

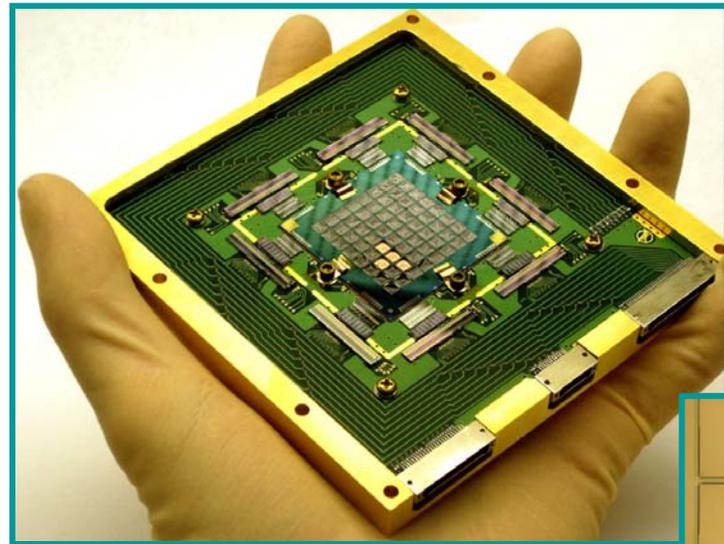
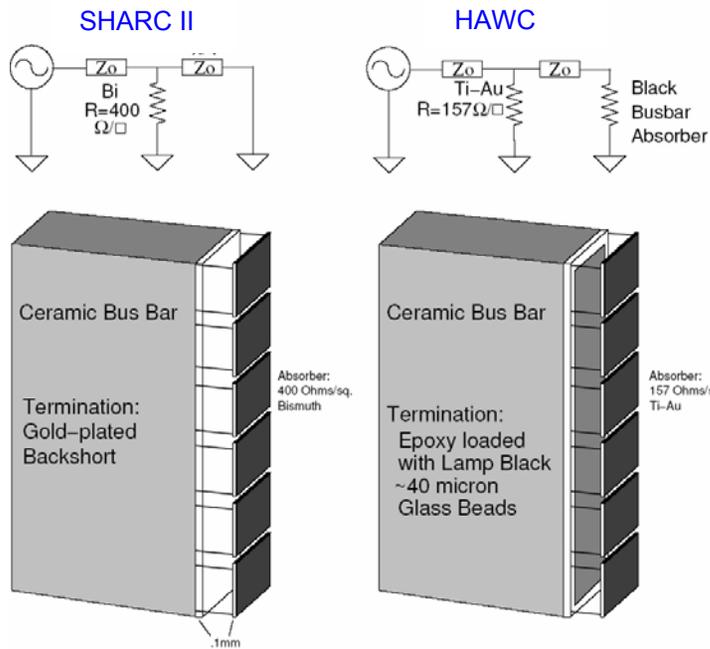
- Appropriate Environment for Sensor
- Cold Stage ~ 200 mK, ~ 10 μ W load

Pixellated Array in Focal Plane:

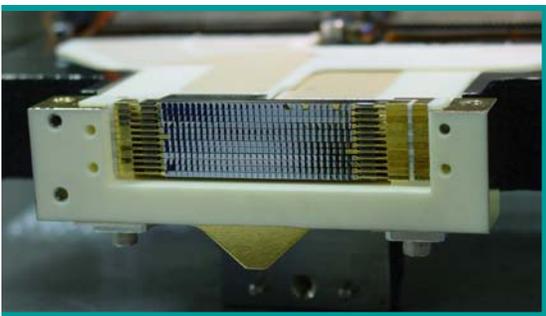
- Image from Multiple Sensors Elements
- Temporal Response Defined by Sensor Electro-Thermal Time Constant



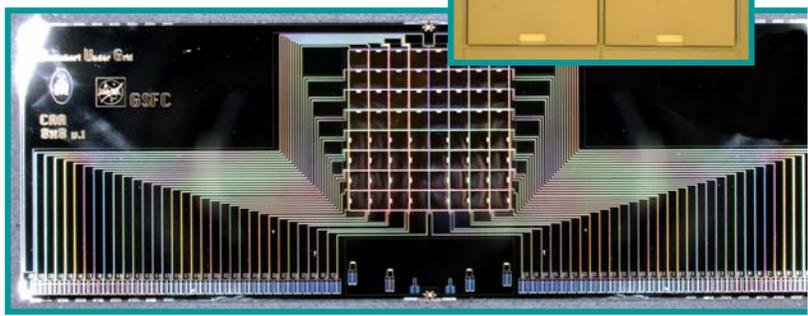
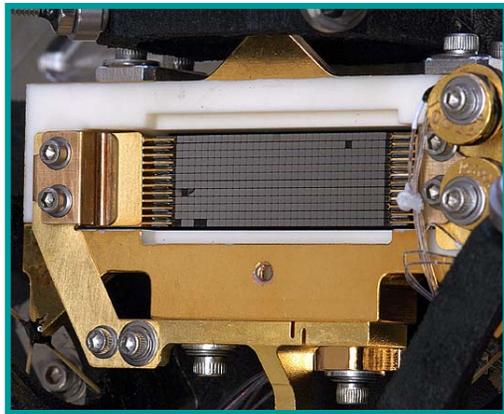
Pixellated Array: Implementations



GBT



Micro-machined Silicon "Pop-Up"



Back-Terminated Grid Array

GISMO

Wollack et al., 2006 – Future GBT Instrumentation Workshop

Selected Array Parameters:

| Instrument | p/λ | Array Size / Detector Type | Back Termination | Wavelength |
|------------|----------------------|--------------------------------|---------------------|----------------------------|
| ACT | 0.50 0.75 0.88 | 32 x 32 TES | Absorber | 2.0mm 1.3mm 1.1mm |
| GISMO | 1.00 | 8 x 16 TES | Short | 2.0mm |
| GBT | 1.00 | 8 x 8 TES | Short | 3.0mm |
| SCUBA 2 | 2.52 1.34 | 64 x 64 / TES 32 x 32 / TES | Short | 0.45mm 0.85mm |
| SHARC II | 2.86 2.22 1.18 | 12 x 32 Semiconductor | Short | 0.35mm 0.45mm 0.85mm |
| HAWC | 3.3-to-20 | 12 x 32 Semiconductor | Absorber | 0.05-to-0.3mm |

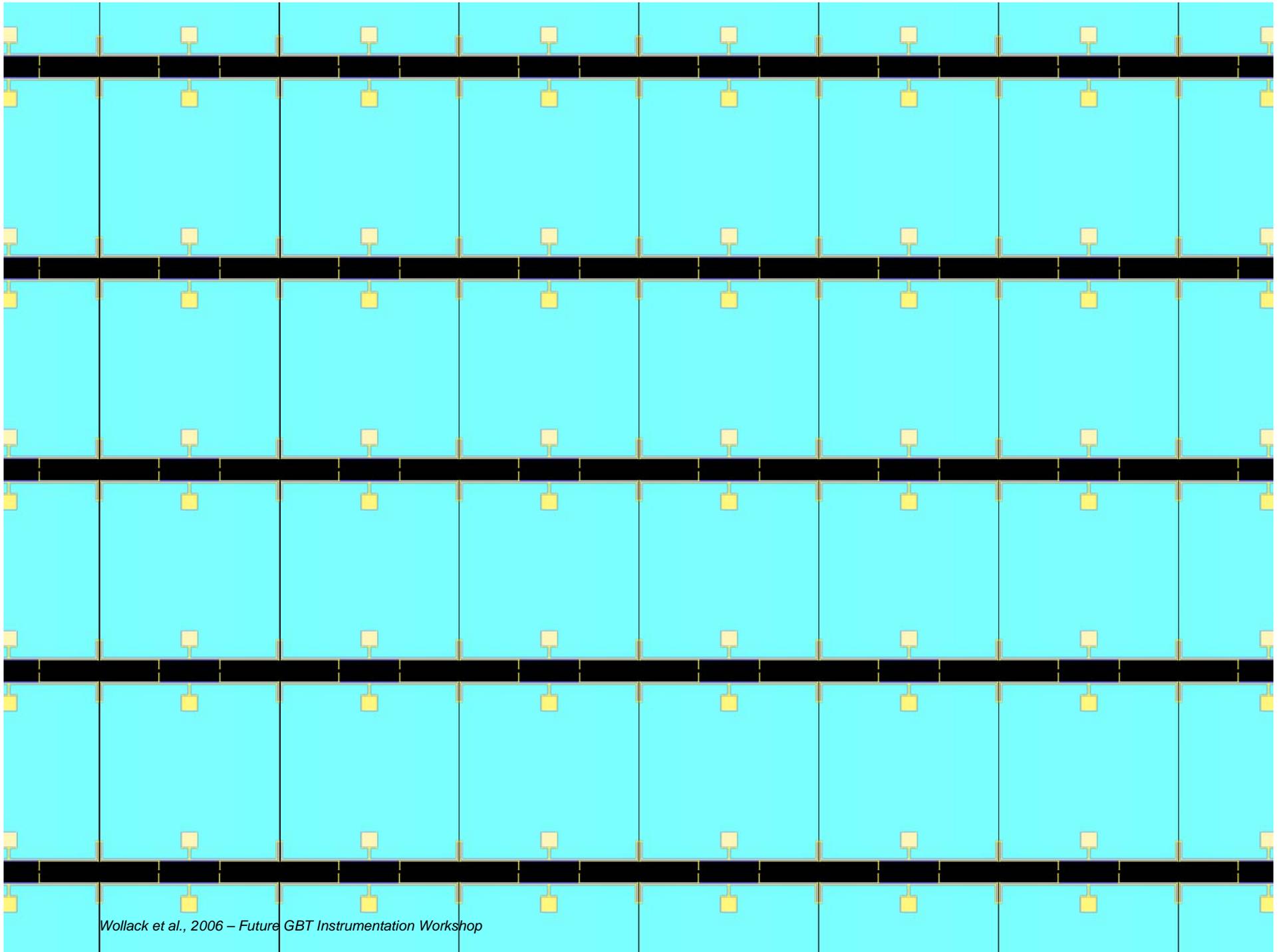
Pixellated Arrays: Practical Limits

- Electromagnetic Considerations:
 - Lagrange / Helmholtz Invariant: $A_{\text{eff}} \Omega_b / \lambda^2 = N_{\text{modes}}$
 - Uncertainty Principle: $\Delta x \Delta k > 1/2$
 - Rayleigh Resolution – Pixel Angular Acceptance
 - Diffraction – Instrumental Polarization and Coupling Efficiency
 - Hanbury-Brown-Twiss – Inherent Image Correlations
 - Coupling: Convert incident fields from plane-wave to sensor mode set with high absorption efficiency without loss of spatial information...
- Information Theoretic Considerations:
 - Nyquist: Telescope is Spatial/Temporal Low-Pass Filter
 - Shannon: $S = \det[\log(1 + G_{ij} N^{-1} G_{ij})]$ – need to understand and characterize correlations

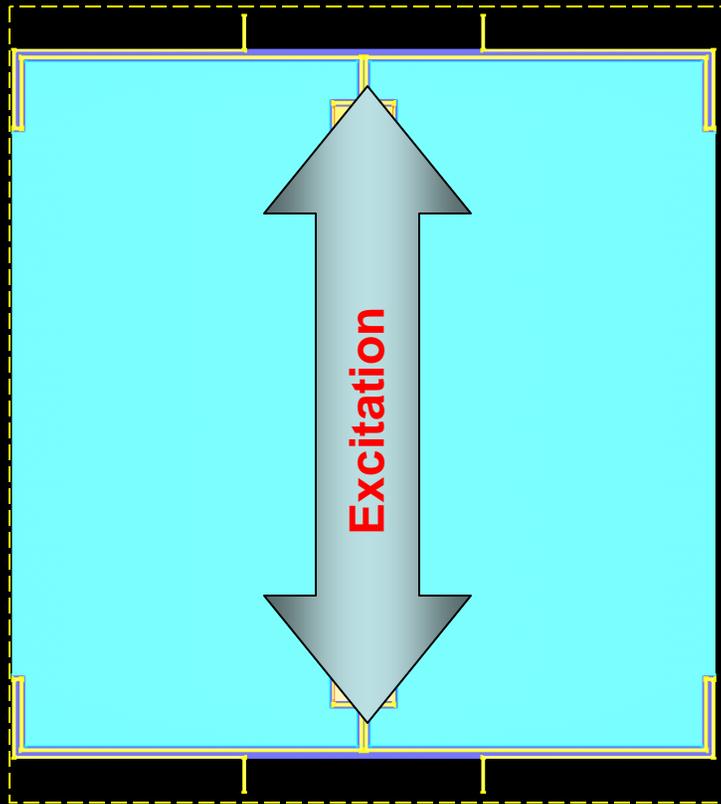
Objective: *Maximize information extraction from image by sensor...*

Senor Array: Design Considerations

- Relatively Fast Optics...
 - Absorption Efficiency: Polarization Dependent on Incidence Angle...
 - Mutual Coupling: Degraded Noise / Angular Resolution...
 - Reflections: Ghosting in Optics...
 - Band Pass: Function of radiation incident angle and collimation...
(e.g., $\Delta v_{\text{eff}} \sim v_o / 2 (2 n_{\text{eff}} f)^2 \dots$)
- Inter-Element Correlations a Function of Detector Pitch, Absorber Geometry, and Wavelength...
- Fabrication...
 - Control / Limit Interlayer Spacing and Geometry → Polarization
 - Multimode or Appropriately Symmetrized Absorber Design
 - Mechanical Backshort Spacing / Geometry → Coupling
 - Bolometric Absorber Process and Validation → Device Stability



Pixellated Array Element:



- Lossy coating converts incident photons to phonon in absorber membrane...
- Thermal sensor will have finite area with a surface impedance differing from that of the absorber, electrically long leads for electrical read out and bias...
- Other Influences:
 - Gaps for Thermal Conductance
 - Minimal Heat Capacity...
 - Calibration/Bias Heater
 - Finite Array Size / Edge Effects
 - etc...

The effects of these design parameters on the absorptance can be studied for plane wave illumination via 3D electromagnetic simulation for each polarization (e.g., Time-Domain TLM or Finite Element methods) by imposing periodic boundary conditions...

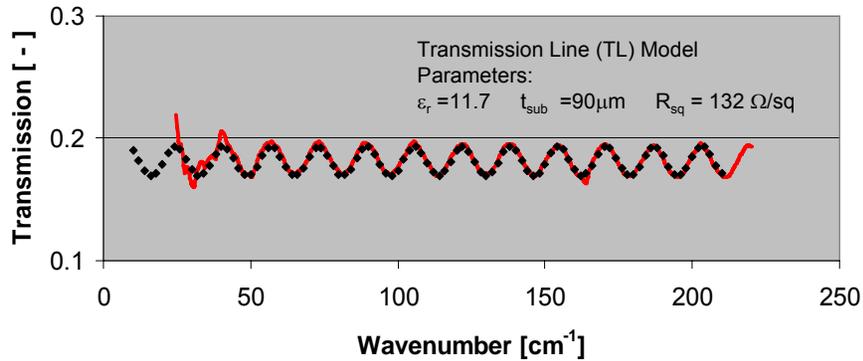
Absorber: Design Considerations

- Compatibility with other sensor processing...
- Predictable performance based upon DC and Optical Witnesses
- Decouple Optical and Thermal Design Constraints
 - Use Electrically Thin Silicon Substrate...
 - Terminate Transmitted Power Cold and Limit FOV...
 - Maximize Sensor Absorption Efficiency
- Circuit Topology and Sensitivity: FSS, Back Termination, etc...

| Coating Composition: | Bi | Cr/Au | Pd/Au | Ti/Au | Silicon Implant |
|---------------------------|------------|------------------------|-------------------------------|------------------------|--------------------------|
| Conduction Mechanism: | Semi-Metal | Disordered Metal Alloy | Disordered Metal Alloy | Disordered Metal Alloy | Degenerate Semiconductor |
| Surface Reactance? | -- | ++ | ++ | ++ | ++ |
| Electrical Time Constant? | - | ++ | ++ | ++ | + |
| Heat Capacity? | ++ | + (magnetic) | -- (large elec. γ) | ++ | ++ |
| Long Term Stability? | + | - | + | + | ++ |

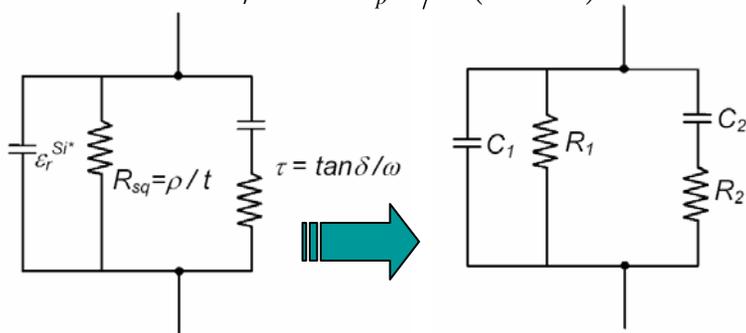
Absorber: Finite Scattering Time

HAWC TiAu_Si Witness: @ 300K



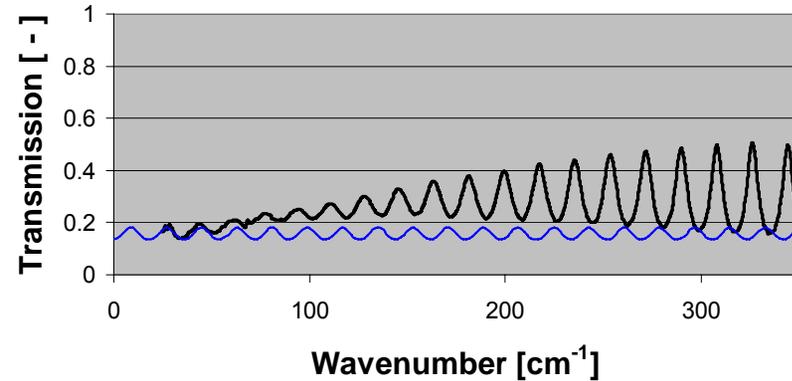
• TL Model — 5251.7200 RH8

$$\begin{aligned} \epsilon_r(\omega) &\cong \epsilon_r^{Si^*} + i\sigma(\omega)/\epsilon_o\omega \\ &= \epsilon_r^{Si^*} + i \cdot \omega_p^2 \tau / \omega(1 - i\omega\tau) \end{aligned}$$



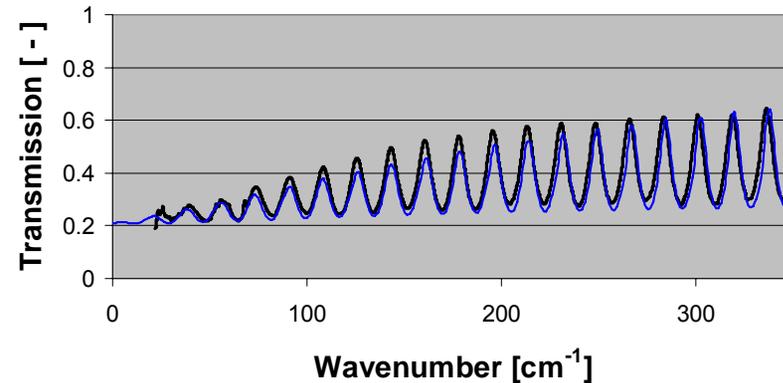
Physical and Lumped Element Model for Absorber with a finite relaxation timescale...

Drude TLM: $T_a=5\text{K}$ $\epsilon_r=11.5$, $t=82\mu\text{m}$ $R_{\text{sq}}\sim 110\Omega/\text{sq}$ $\tau\sim 0\text{fs}$



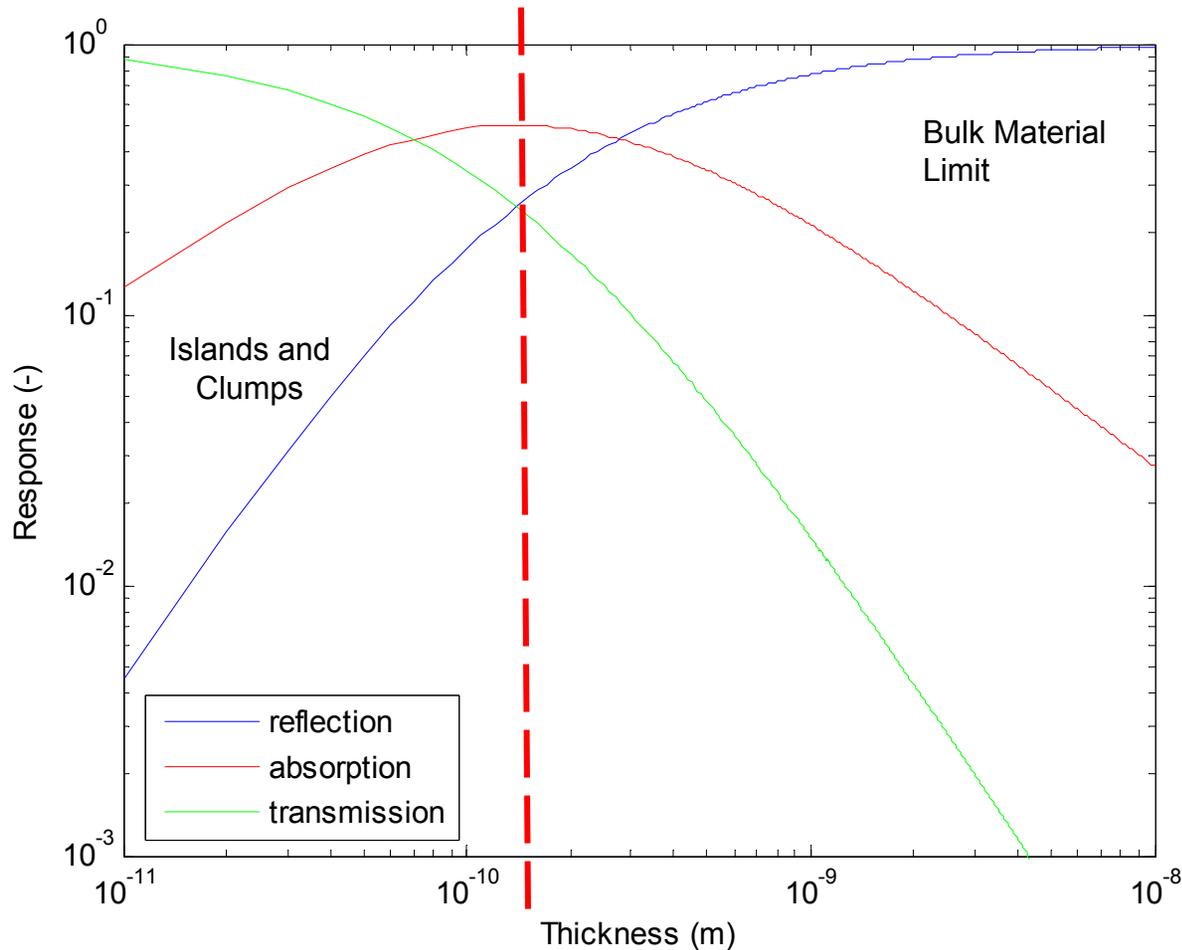
— Bi_on_Silicon_#6_031505_T_F(c)_005_(041505).txt
— Drude TLM: Transmittance

Drude TLM: $T_a=5\text{K}$ $\epsilon_r=11.5$, $t=83\mu\text{m}$ $R_{\text{sq}}\sim 160\Omega/\text{sq}$ $\tau\sim 38\text{fs}$ $p=1$ $E_f=34\text{meV}$



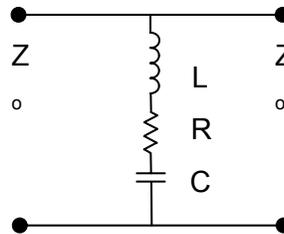
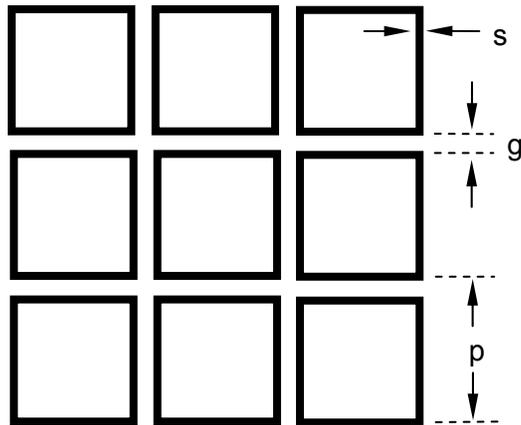
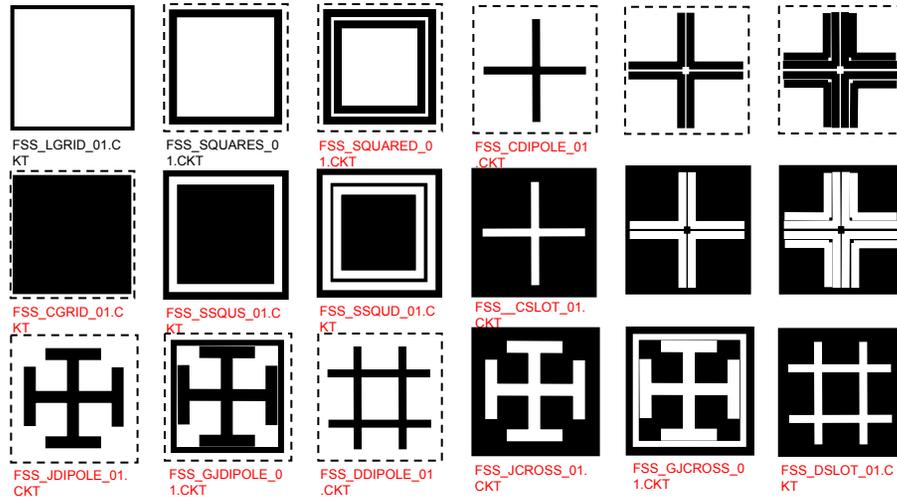
— Implanted Si_g10_40keV_#7_T_F(c)_005_(033005).txt
— Drude TLM: Transmittance

Frequency Independent Absorber: Thin Film Resistor Metallization



- To approximate ideal resistor, desire ohmic thin film with thickness \ll penetration depth over band of interest...
- Semi-metal, disorder alloy, and degenerately doped implant can produced the desired impedance levels at long wavelengths...

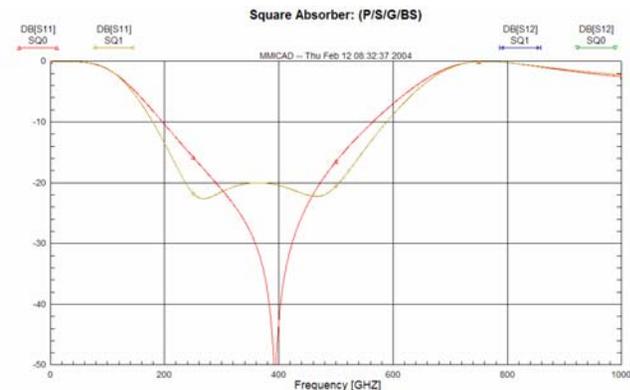
Absorbers: FSS and PSS Elements



Infinite Square Loop Array and Equivalent Circuit Representation...

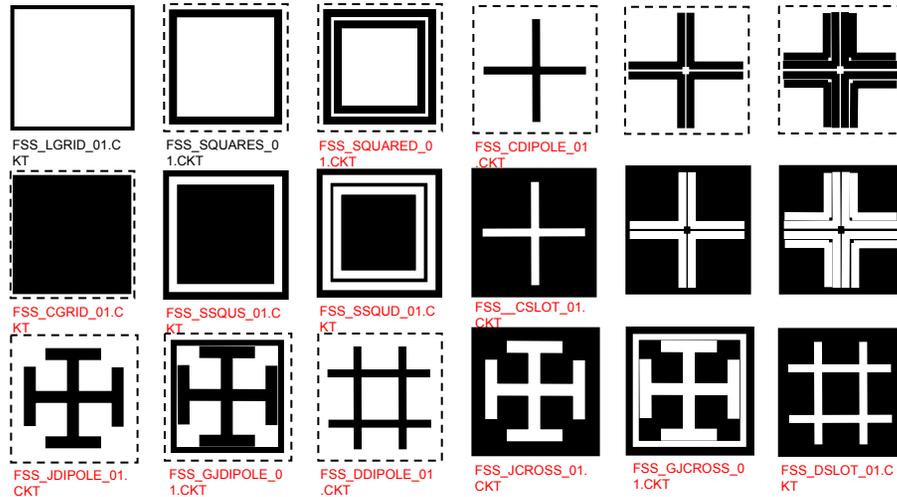
Wollack et al., 2006 – Future GBT Instrumentation Workshop

- Theoretical Investigation of Frequency and Polarization Sensitivity Surface Configurations...
 - Geometry
 - Absorption/Emission Efficiency
 - Bandwidth
 - Substrate Dielectric Loading
 - Inter-pixel Correlation when Elements are used as Focal Plane Array Detector Absorbers
 - Tolerance / Sensitivity Study
 - Polarization Purity
- Derivation and Finite Element Validation of Computational Efficient Lumped Circuit Element Models...

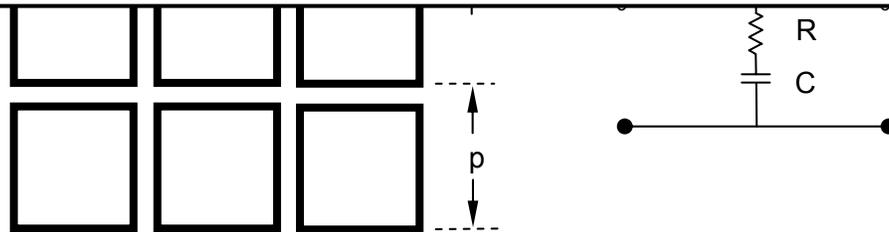


Absorbers: FSS and PSS Elements

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For low p/λ gaps between elements can not be ignored – the structure is a capacitive mesh lowpass filter with ohmic loss...

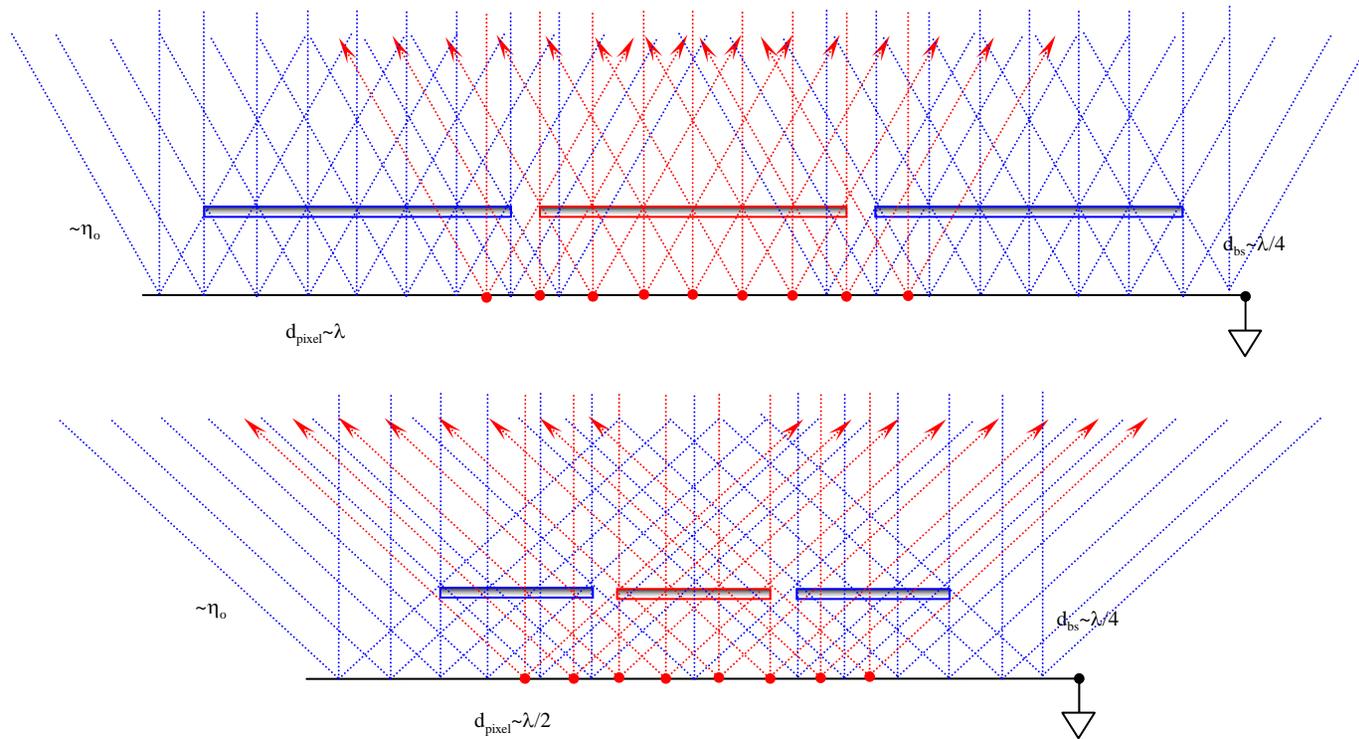


Infinite Square Loop Array and Equivalent Circuit Representation...

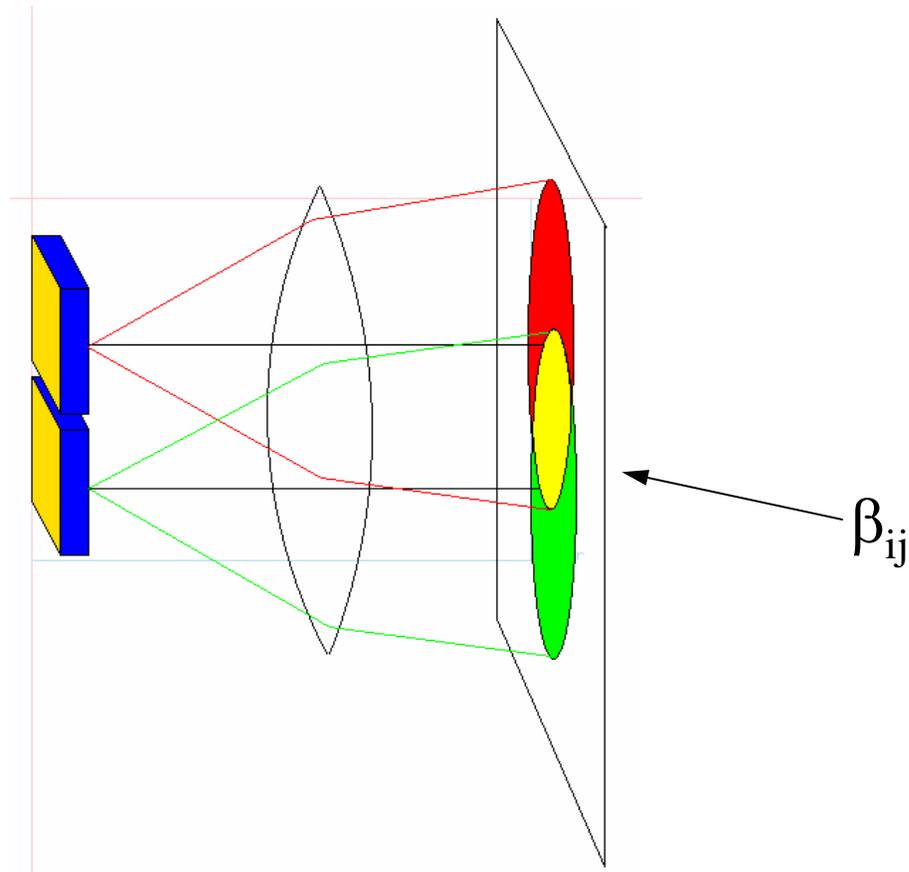
Derivation and Finite Element Validation of Computational Efficient Lumped Circuit Element Models...



Pixel Coupling: Beam Overlap

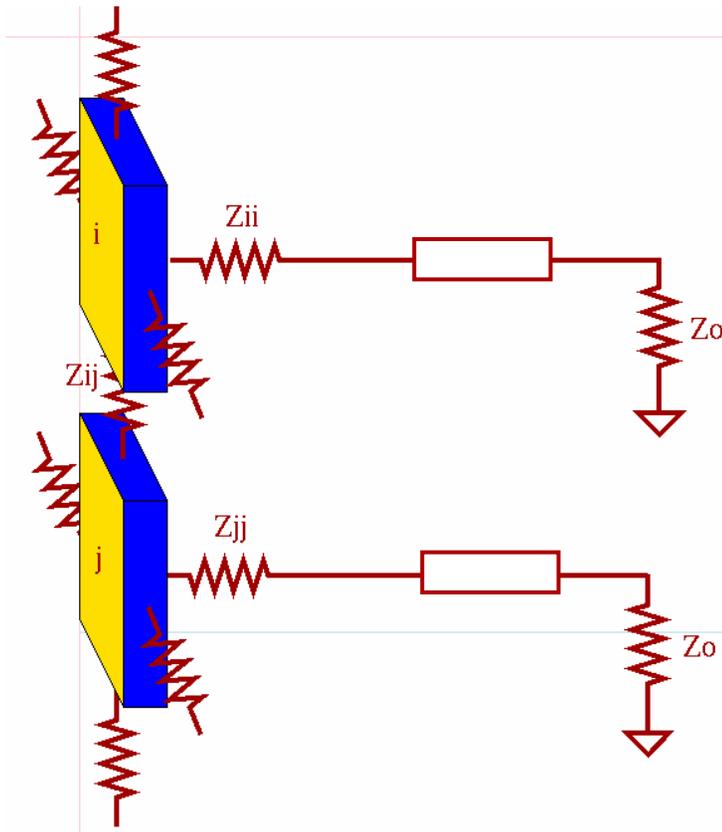


Pixel Coupling: Beam Overlap



Equivalently, treat array elements as quasioptical power splitter and consider at beam overlap at infinity...

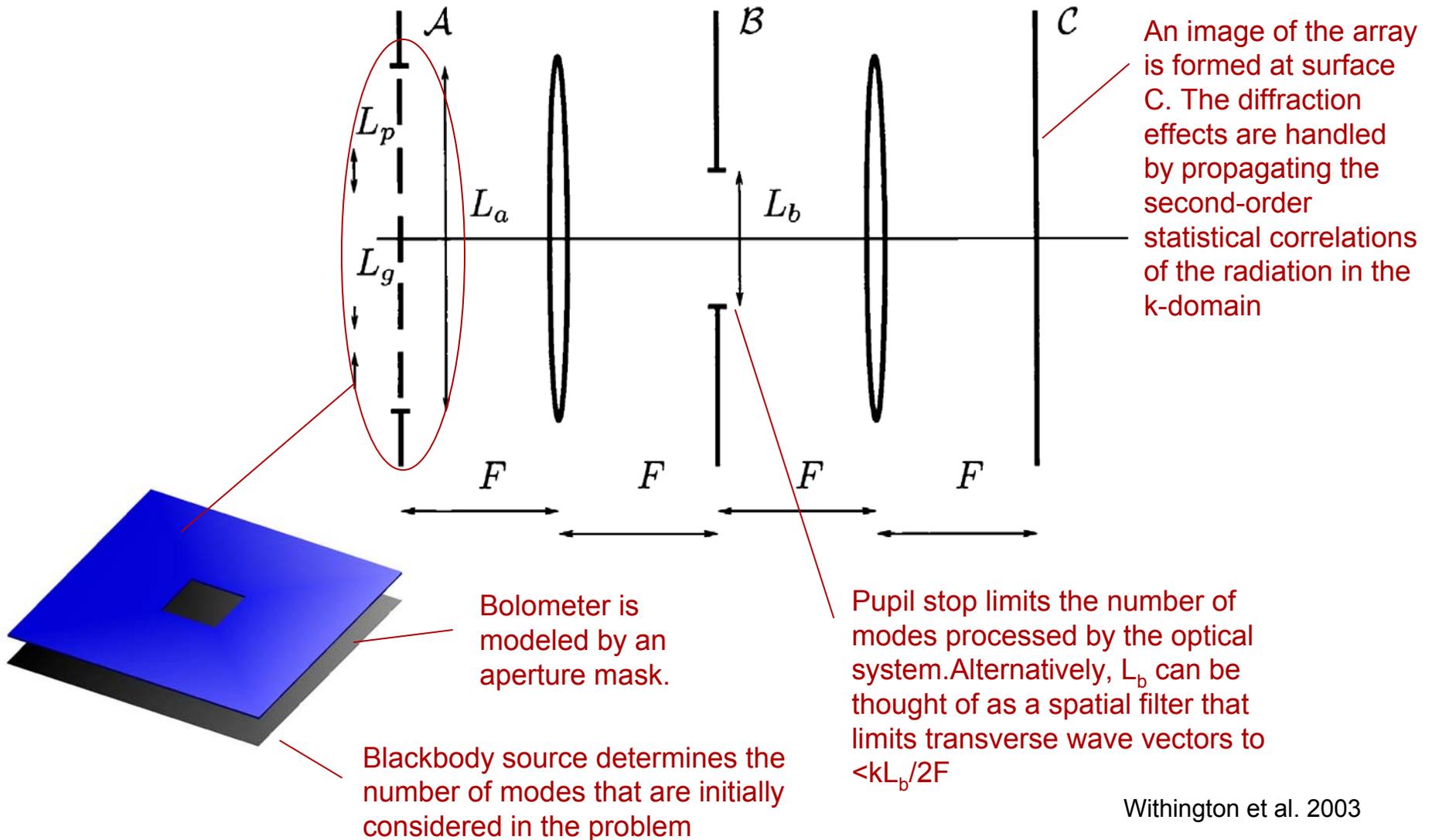
Pixel Coupling: Mutual Impedance



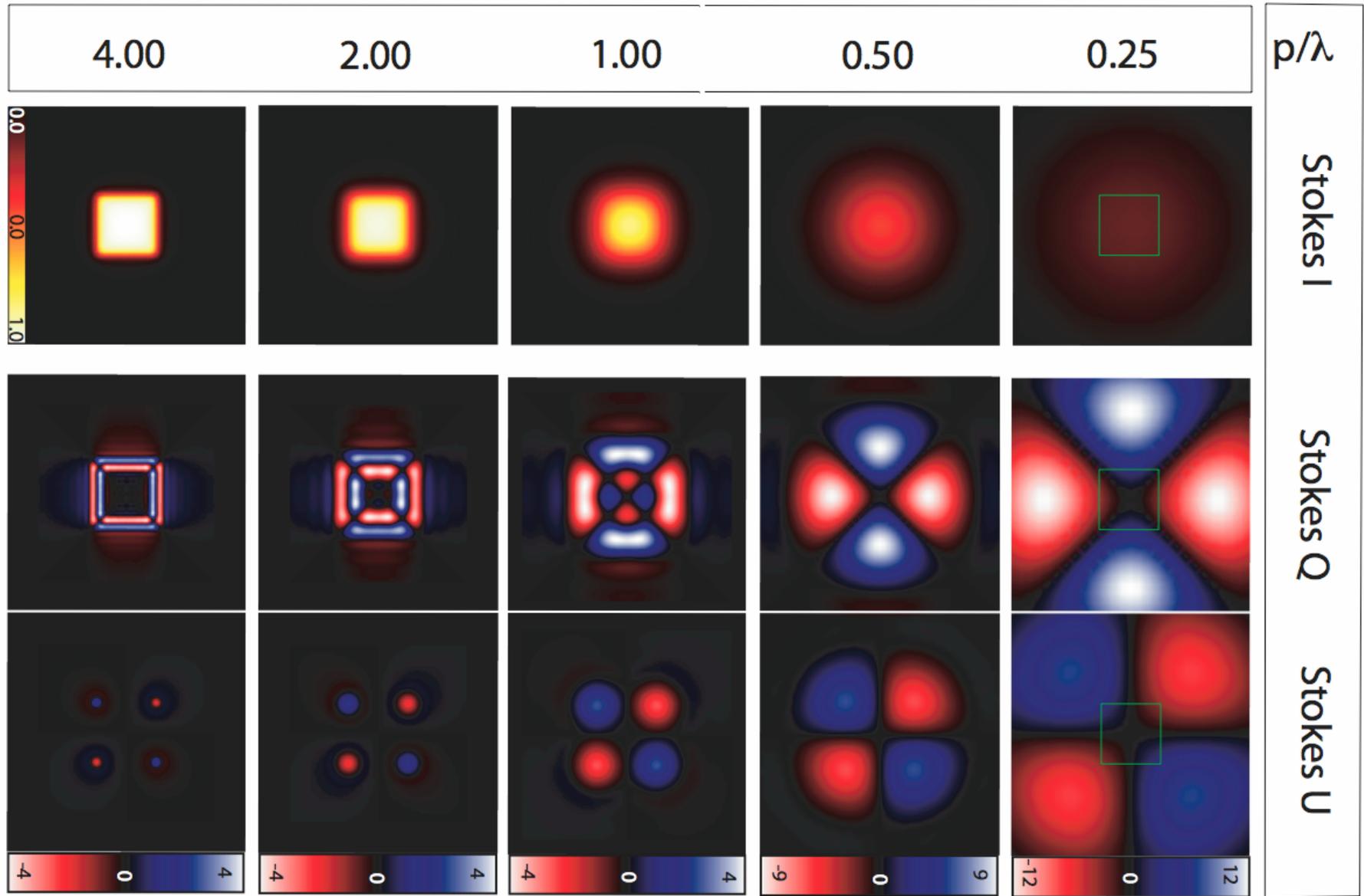
$$Z_m \approx \frac{2R_{rad}l^2}{r_{ij}\lambda_o} \sin \vartheta_i \sin \vartheta_j \exp(-j2\pi r_{ij} / \lambda_o)$$

Consider impedance matrix for array of elements. Terminate all elements in array terminated except pair – currents on one pixel couple to other...

Multimode Optical Response:



Withington et al. 2003



Polarization Response...

Observation: If detectors response is different for orthogonal polarizations, uncertainty introduced in calibration / measurement of photometric flux. Effect is estimated to be several percent level a millimeter wavelengths...

Solution: 1) Ensure that the polarized response of the detector is negligible, 2) Keep track of the polarization, 3) Other...

| Solution | Loss | Reflections | Bandwidth | Fabrication |
|------------------------------|------|-------------|-----------|-------------|
| Symmetrize absorber (1-side) | + | + | - | + |
| Diagonal mesh (2-sides) | + | + | + | -- |
| Single polarization only | -- | -- | + | + |
| Absorb wave after absorber | -- | -- | + | -- |
| Polarizer in front of array | -- | -- | + | + |
| Rotating QWP | - | - | + | + |
| Rotating HWP | - | - | -- | + |
| Variable Delay Modulator | - | - | + | + |

SHARC II:
 857 GHz (350 microns)
 384 elements 1mm pixels
 Inter-Pixel Correlation ~4%
 Nyquist Sampled
 CSO: 10.4 m primary
 8.3" FWHM

